

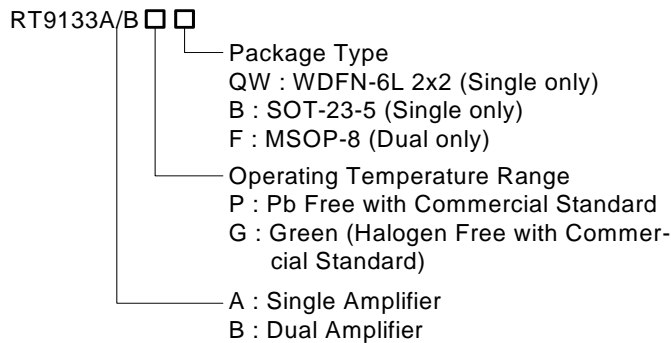
Rail-to-Rail Operational Amplifier

General Description

The RT9133A/B consist low cost, high slew rates, single-supply rail-to-rail input and output operation amplifiers. The RT9133A contains a single amplifier and RT9133B contains two amplifiers. The RT9133A/B have high slew rates (12V/us), 35mA continuous output current, 120mA peak output current and offset voltage below 10mV. The RT9133A/B are ideal for Thin Film Transistor Liquid Crystal Displays (TFT-LCD).

The RT9133A is available in SOT-23-5 and WDFN-6L 2x2 packages. The RT9133B is available in MSOP-8 package. The RT9133A/B are specified for operation over the full -40°C to +85°C temperature range.

Ordering Information



Note :

Richtek Pb-free and Green products are :

- ▶RoHS compliant and compatible with the current requirements of IPC/JEDEC J-STD-020.
- ▶Suitable for use in SnPb or Pb-free soldering processes.
- ▶100% matte tin (Sn) plating.

Marking Information

For marking information, contact our sales representative directly or through a Richtek distributor located in your area, otherwise visit our website for detail.

Features

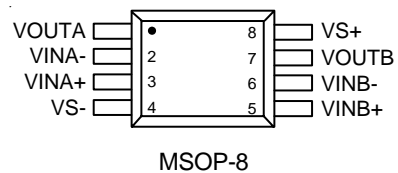
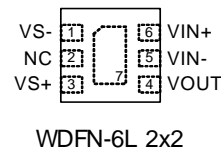
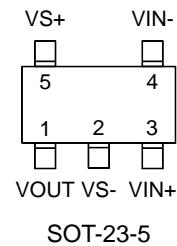
- Rail-to-Rail Output Swing
- Supply Voltage : 4.5V to 15V
- Continuous Output Current : 35mA
- Peak Output Current : 120mA
- High Slew Rate : 12V/μs
- Offset Voltage : 10mV
- RoHS Compliant and 100% Lead (Pb)-Free

Applications

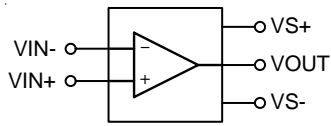
- TFT-LCD Gamma / V_{COM} Buffer
- Portable Electronic Product
- Communications Product

Pin Configurations

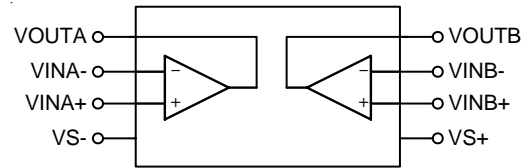
(TOP VIEW)



Function Block Diagram



RT9133A



RT9133B

Functional Pin Description

Single

Pin No.		Pin Name	Pin Function
SOT-23-5	WDFN-6L 2x2		
1	4	VOUT	Amplifier Output.
--	2, Exposed Pad (7)	NC	No Internal Connection.
2	1	VS-	Negative Power Supply.
3	6	VIN+	Amplifier Non-Inverting Input.
4	5	VIN-	Amplifier Inverting Input.
5	3	VS+	Positive Power Supply.

Dual

Pin No.	Pin Name	Pin Function
1	VOUTA	Amplifier A Output.
2	VINA-	Amplifier A Inverting Input.
3	VINA+	Amplifier A Non-Inverting Input.
4	VS-	Negative Power Supply.
5	VINB+	Amplifier B Non-Inverting Input.
6	VINB-	Amplifier B Inverting Input.
7	VOUTB	Amplifier B Output.
8	VS+	Positive Power Supply.

Absolute Maximum Ratings (Note 1)

- Supply Voltage ----- 17V
- Power Dissipation, P_D @ $T_A = 25^\circ\text{C}$
 - SOT-23-5 ----- 500mW
 - WDFN-6L 2x2 ----- 758mW
 - MSOP-8 ----- 781mW
- Package Thermal Resistance (Note 4)
 - SOT-23-5, θ_{JA} ----- 250°C/W
 - WDFN-6L 2x2, θ_{JA} ----- 165°C/W
 - MSOP-8, θ_{JA} ----- 160°C/W
- Differential Input Voltage ----- V_S
- Lead Temperature (Soldering, 10 sec.) ----- 260°C
- Storage Temperature Range ----- -65°C to $+150^\circ\text{C}$
- ESD Susceptibility (Note 2)
 - HBM (Human Body Mode) ----- 2kV
 - MM (Machine Mode) ----- 200V

Recommended Operating Conditions (Note 3)

- Input Voltage ----- -0.5V to $V_S+0.5\text{V}$
- Junction Temperature Range ----- -65°C to $+150^\circ\text{C}$
- Ambient Temperature Range ----- -40°C to $+85^\circ\text{C}$

Note 1. Stresses listed as the above “Absolute Maximum Ratings” may cause permanent damage to the device. These are for stress ratings. Functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may remain possibility to affect device reliability.

Note 2. Devices are ESD sensitive. Handling precaution recommended.

Note 3. The device is not guaranteed to function outside its operating conditions.

Note 4. θ_{JA} is measured in the natural convection at $T_A = 25^\circ\text{C}$ on a low effective thermal conductivity test board (single layer, 1S) of JEDEC 51-3 thermal measurement standard.

Electrical Characteristics(V_S = +5V, V_S = -5V, R_L = 10kΩ and C_L = 10pF to 0V, T_A = 25°C, unless otherwise specified)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Units
Input Characteristics						
Input Offset Voltage	V _{OS}	V _{CM} = 0	--	2	15	mV
Average Offset Voltage Drift	ΔV _{OS} /ΔT	-40°C ≤ T _A ≤ 85°C	--	5	--	uV/°C
Input Bias Current	I _B	V _{CM} = 0	--	2	50	nA
Input Impedance	R _{IN}		--	1	--	GΩ
Input Capacitance	C _{IN}		--	1.35	--	pF
Common-Mode Input Range	CMIR		-5.5	--	+5.5	V
Common-Mode Rejection Ratio	CMRR	For V _{IN} from -5.5V to +5.5V	50	80	--	dB
Open-Loop Gain	A _{VOL}	-4.5V ≤ V _{OUT} ≤ +4.5V	75	95	--	dB
Output Characteristics						
Output swing Low	V _{OL}	I _L = -5mA	--	-4.92	-4.85	V
Output swing High	V _{OH}	I _L = +5mA	4.85	4.92	--	V
Continuous V _{COM} Buffer Output current	I _{OC}		--	±35	--	mA
Peak V _{COM} Buffer Output current	I _{PC}		--	±120	--	mA
Power Supply						
Supply Voltage	V _S		4.5	--	15	V
Power Supply Rejection Ratio	PSRR	V _S is moved from ±2.25V to ±7.75V	60	70	--	dB
Supply Current/Amplifier	I _{SY}	No Load	--	500	750	uA
Dynamic Performance						
Slew Rate(Note)	SR	-4.0V ≤ V _{OUT} ≤ +4.0V, 20% to 80%	--	12	--	V/us
Setting to ±0.1% (A _V = +1)	t _S	(A _V = +1), V _{OUT} = 2V step	--	500	--	ns
-3dB Bandwidth	BW	R _L = 10kΩ, C _L = 10 pF	--	12	--	MHz
Gain-Bandwidth Product	GBWP	R _L = 10kΩ, C _L = 10 pF	--	5	--	MHz
Phase Margin	PM	R _L = 10kΩ, C _L = 10 pF	--	50	--	°
Channel Separation	CS	f = 5MHz	--	75	--	dB

Note: Slew rate is measured on rising and falling edges.

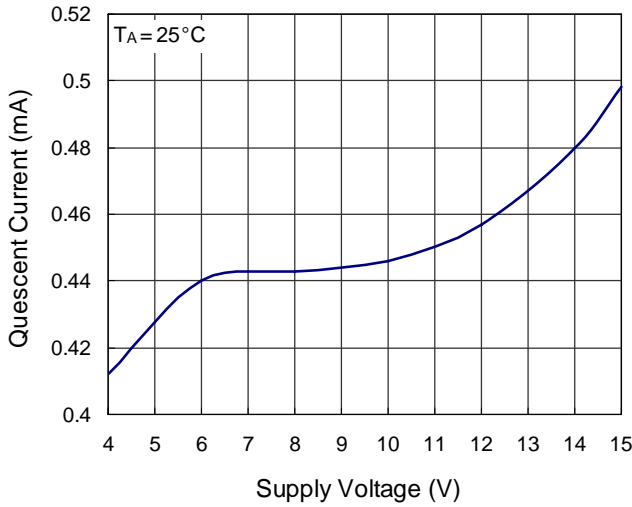
($V_{S+}=+2.5V$, $V_{S-} = -2.5V$, $R_L = 10k\Omega$ and $C_L = 10pF$ to 2.5V, $T_A = 25^\circ C$, unless otherwise specified)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Units
Input Characteristics						
Input Offset Voltage	V_{OS}	$V_{CM} = 2.5V$	--	2	15	mV
Average Offset Voltage Drift	$\Delta V_{OS}/\Delta T$	$-40^\circ C \leq T_A \leq 85^\circ C$	--	5	--	$\mu V/^\circ C$
Input Bias Current	I_B	$V_{CM} = 2.5V$	--	2	50	nA
Input Impedance	R_{IN}		--	1	--	$G\Omega$
Input Capacitance	C_{IN}		--	1.35	--	pF
Common-Mode Input Range	CMIR		-0.5	--	+5.5	V
Common-Mode Rejection Ratio	CMRR	For V_{IN} from $-0.5V$ to $+5.5V$	45	65	--	dB
Open-Loop Gain	A_{VOL}	$0.5V \leq V_{OUT} \leq +4.5V$	75	95	--	dB
Output Characteristics						
Output swing Low	V_{OL}	$I_L = -5mA$	--	-2.42	-2.35	mV
Output swing High	V_{OH}	$I_L = +5mA$	2.35	2.42	--	V
Continuous V_{COM} Buffer Output current	I_{OC}		--	± 35	--	mA
Peak V_{COM} Buffer Output current	I_{PC}		--	± 90	--	mA
Power Supply						
Power Supply Rejection Ratio	PSRR	V_S is moved from $\pm 2.25V$ to $\pm 7.75V$	45	70	--	dB
Supply Current/Amplifier	I_{SY}	No Load	--	500	750	μA
Dynamic Performance						
Slew Rate(Note)	SR	$-4V \leq V_{OUT} \leq +4V$, 20% to 80%	--	12	--	V/ μs
Setting to $\pm 0.1\%$ ($A_V = +1$)	t_S	($A_V = +1$), $V_{OUT} = 2V$ step	--	500	--	ns
-3dB Bandwidth	BW	$R_L = 10k\Omega$, $C_L = 10 pF$	--	12	--	MHz
Gain-Bandwidth Product	GBWP	$R_L = 10k\Omega$, $C_L = 10 pF$	--	5	--	MHz
Phase Margin	PM	$R_L = 10k\Omega$, $C_L = 10 pF$	--	50	--	$^\circ$
Channel Separation	CS	$f = 5MHz$	--	75	--	dB

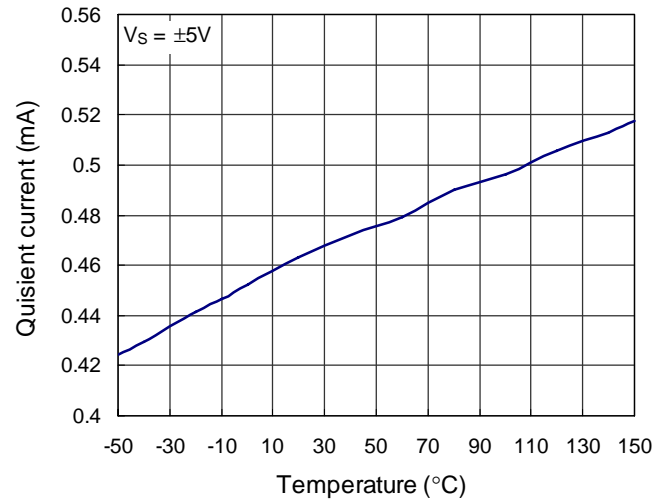
Note: Slew rate is measured on rising and falling edges.

Typical Operating Characteristics

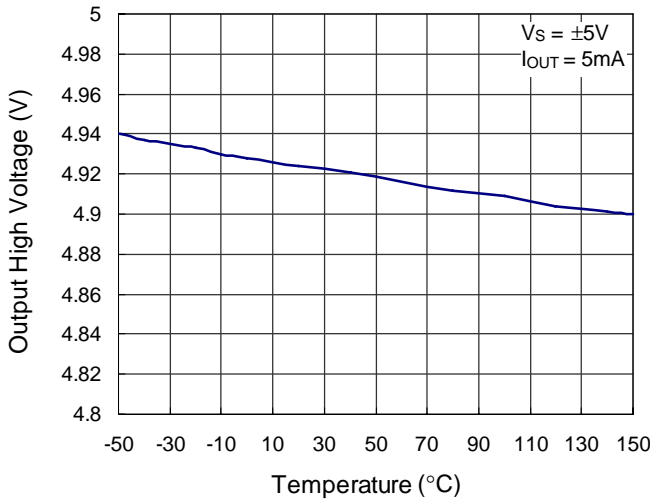
Quiescent Current vs. Supply Voltage



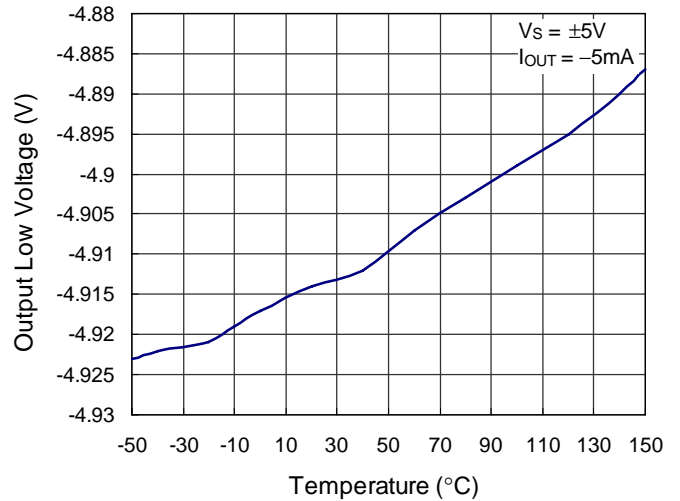
Quiescent current vs. Temperature



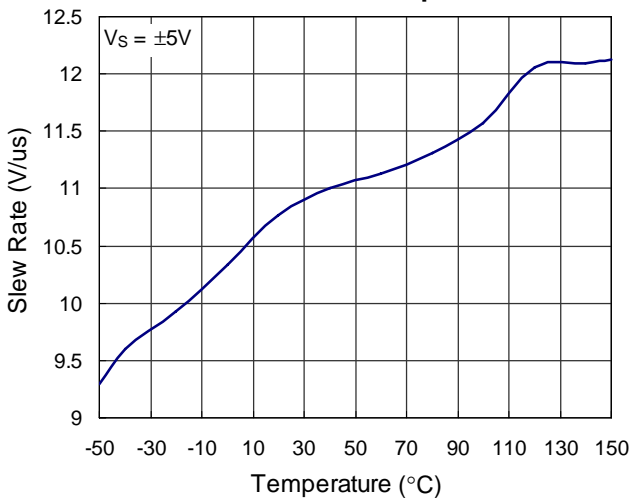
Output High Voltage vs. Temperature



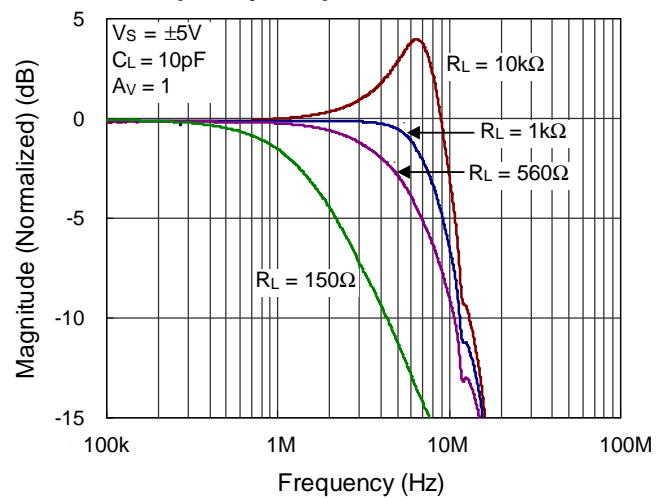
Output Low Voltage vs. Temperature

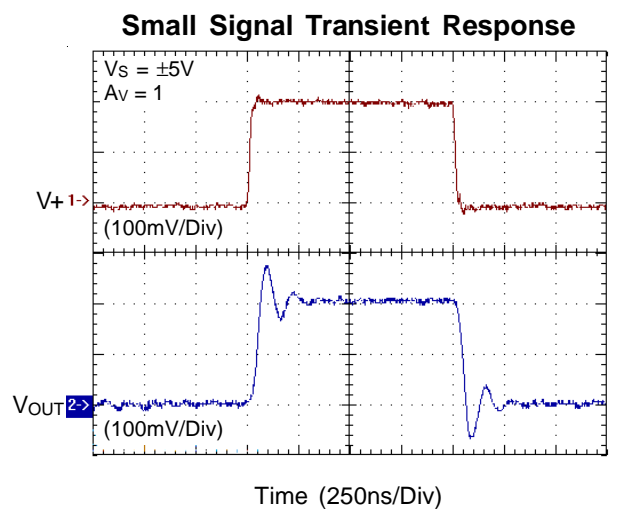
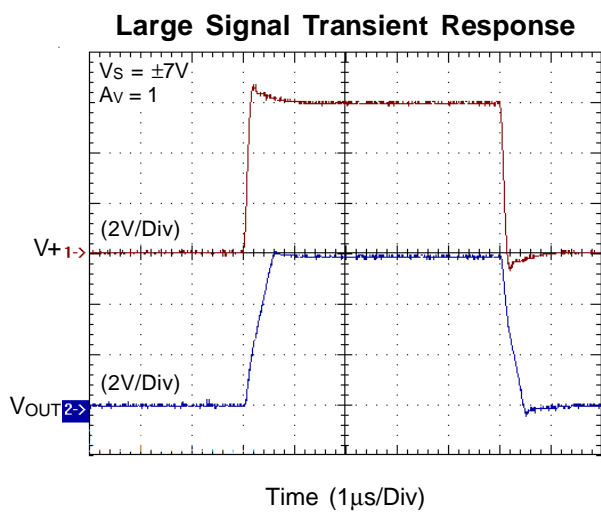
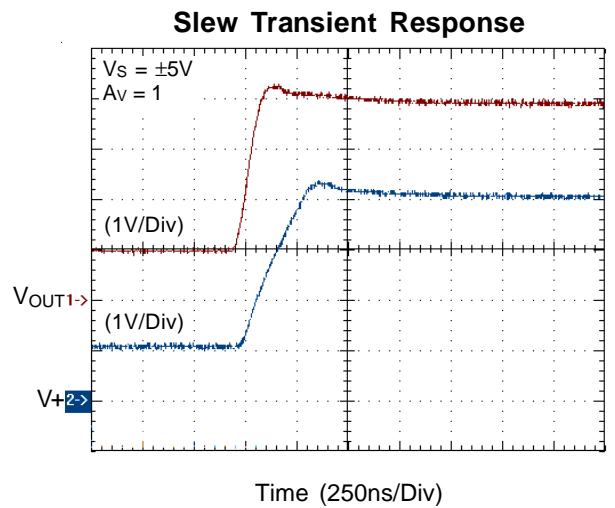
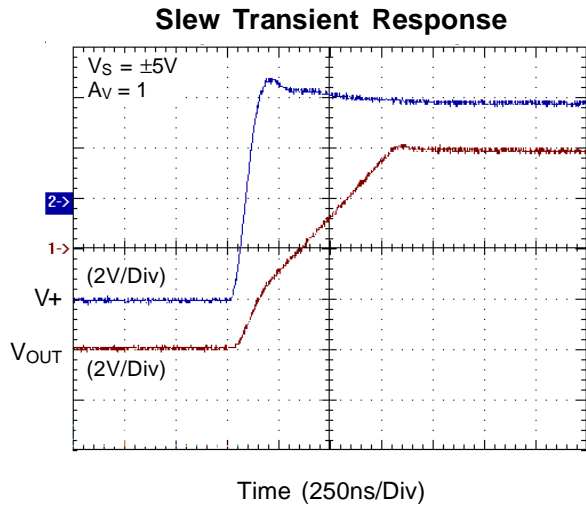
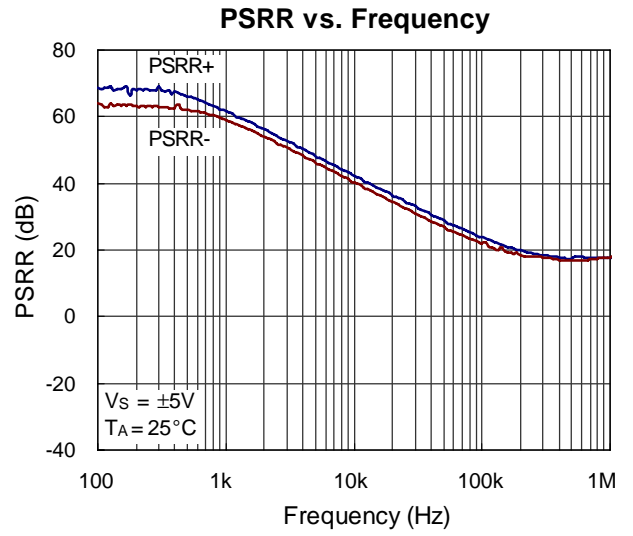
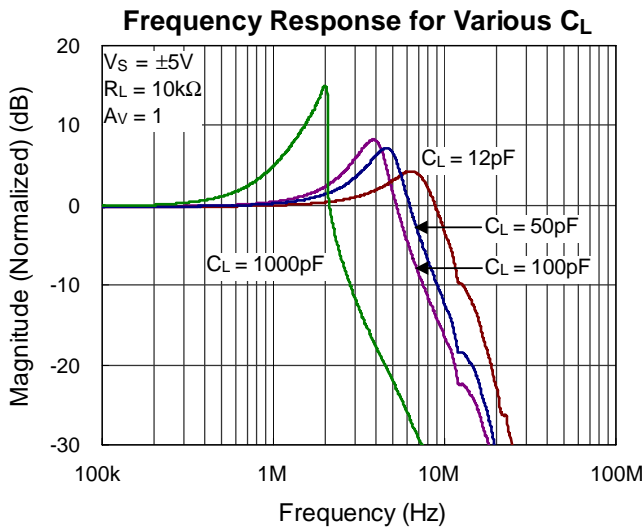


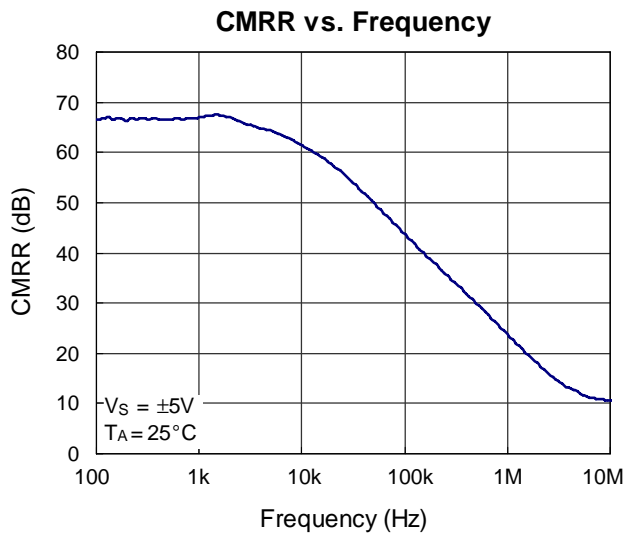
Slew Rate vs. Temperature



Frequency Response for Various RL







Applications Information

The RT9133A/B has high performance to drive large load for different application. High slew rates, rail-to-rail input and output capability and low power consumption are the features to make the RT9133A/B ideal for LCD applications. The RT9133A/B also has wide bandwidth and phase margin to drive a load of 10kΩ and 10pF.

Operating Voltage

The RT9133A/B is specified with single supply voltage from 5V to 15V. According to the electrical characteristics, the total supply voltage range is guaranteed from 4.5V to 15V. To refer the typical operational curves can get stable specifications in wide range of temperature and operating voltage.

The output swing of the RT9133A/B typically extends to within 80mV of positive/negative supply rails with 5mA load current source/sink. Decreasing the load current will get output swing even closer to the supply rails. Figure 1 shows the rail-to-rail input and output waveforms in the unit gain configuration without load current. The supply rails are +/-5V. Applying an input 10Vp_p sinusoidal waveform results in a 9.8Vp_p output voltage as shown in Figure 1.

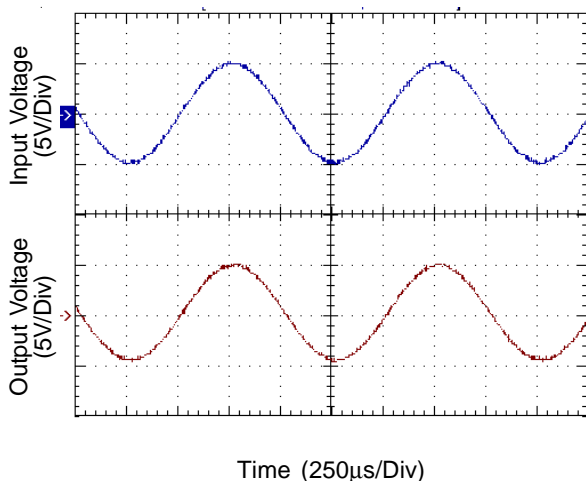


Figure 1. Operation with Rail-to-Rail Input and Output

Power Dissipation

The maximum power dissipation depends on the thermal resistance of IC package, PCB layout, the rate of surroundings airflow and temperature difference between

junction to ambient. The maximum power dissipation can be calculated by following formula:

$$P_{D(MAX)} = (T_{J(MAX)} - T_A) / \theta_{JA}$$

Where

$T_{J(MAX)}$: The maximum operation junction temperature 150°C

T_A : The ambient temperature.

θ_{JA} : The junction to ambient thermal resistance.

The recommended operating condition of RT9133A/B is below the maximum junction temperature 150°C of the die. The junction to ambient thermal resistance for SOT-23-5 package is 250°C/W, WDFN-6L 2x2 package is 165°C/W and MSOP-8 package is 160°C/W on the standard JEDEC 51-3 single layer thermal test board. The maximum power dissipation at $T_A = 25^\circ\text{C}$ can be calculated by following formula:

$$P_{D(MAX)} = (150^\circ\text{C} - 25^\circ\text{C}) / 250 = 500\text{mW (SOT-23-5)}$$

$$P_{D(MAX)} = (150^\circ\text{C} - 25^\circ\text{C}) / 165 = 758\text{mW (WDFN-6L 2x2)}$$

$$P_{D(MAX)} = (150^\circ\text{C} - 25^\circ\text{C}) / 160 = 781\text{mW (MSOP-8)}$$

For continuous operation, do not exceed absolute maximum operation junction temperature 150°C. The power dissipation definition for the RT9133A/B is as following:

$$P_D = (V_S - V_{OUT}) \times I_{Load}$$

V_S : the supply voltage

V_{OUT} : the output voltage

I_{Load} : the output load current

The maximum power dissipation depends on operating ambient temperature for fixed $T_{J(MAX)}$ and thermal resistance θ_{JA} . Figure 2 shows the power dissipation derating curves of the RT9133A/B with different packages. As the ambient temperature increases, the maximum power dissipation decreases linearly to keep the junction temperature below 150°C.

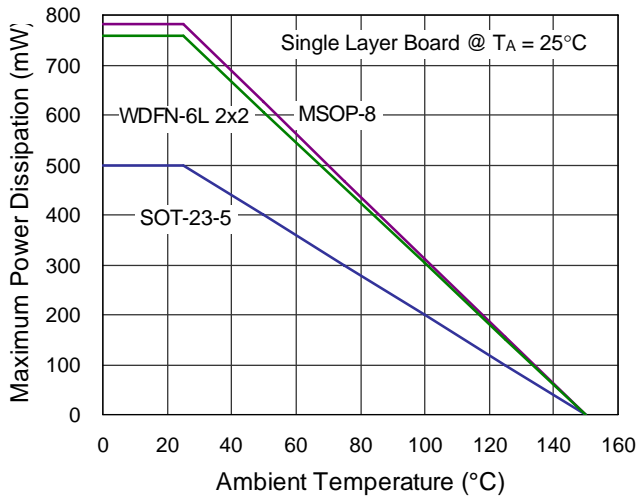


Figure 2. Derating Curves for the RT9133A/B Package

Short Circuit Condition

An internal short-circuit protection circuit is implemented to protect the device from output short circuit. The RT9133A/B limits the short circuit current to $\pm 120\text{mA}$ if the output is directly shorted to positive/negative supply rails. For maximum reliability, the maximum continuous output current more than $\pm 35\text{mA}$ is not recommended.

Unused Amplifier

It is recommended to connect the unused amplifier as a unit gain circuit. The negative input is directly connected to the output and the positive input should be connected to the ground.

LCD Panel Applications

The RT9133A/B is mainly designed for LCD gamma and V-com buffer. OP Amplifier has 120mA instantaneous source/sink peak current. To test the performance of the RT9133A/B for LCD driving capability, the test circuit is to simulate the V-com driver as shown Figure 3. Series capacitors and resistors connected to the output of the OP simulate the load of LCD panel. The 300Ω and 3kΩ feedback resistors are used to improve the settling time. This circuit is the worst case for a V-com buffer. Figure 4 shows the waveforms of the output peak current capability.

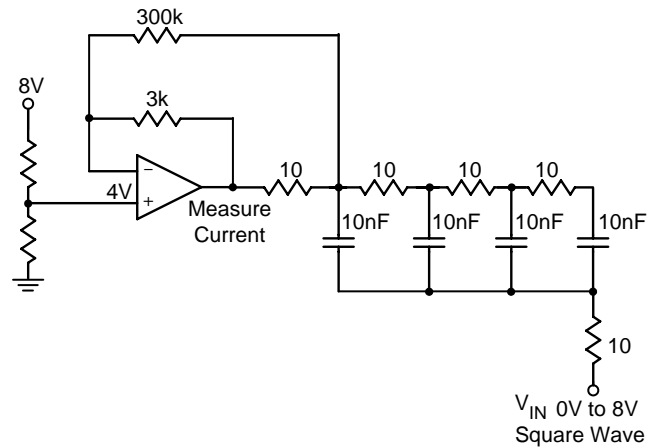


Figure 3. V-com Test Circuit

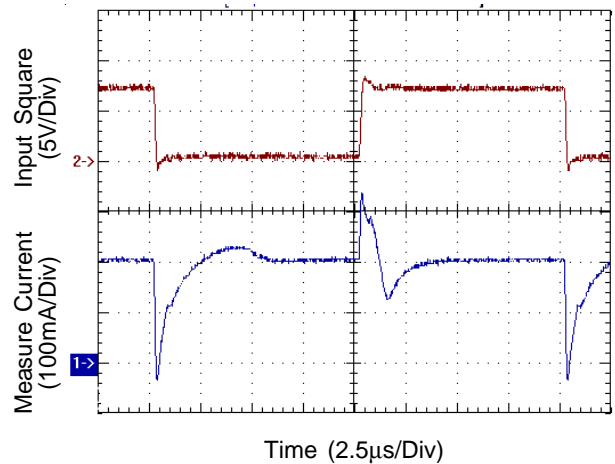
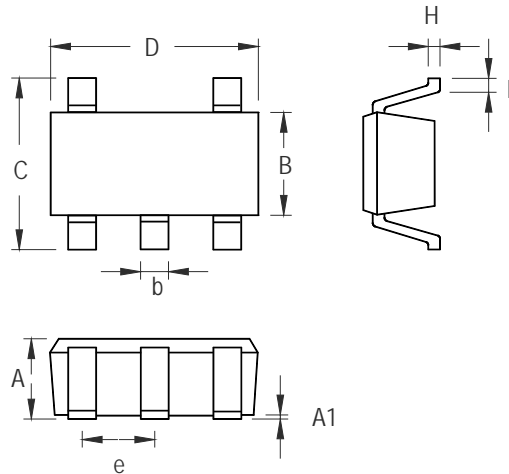


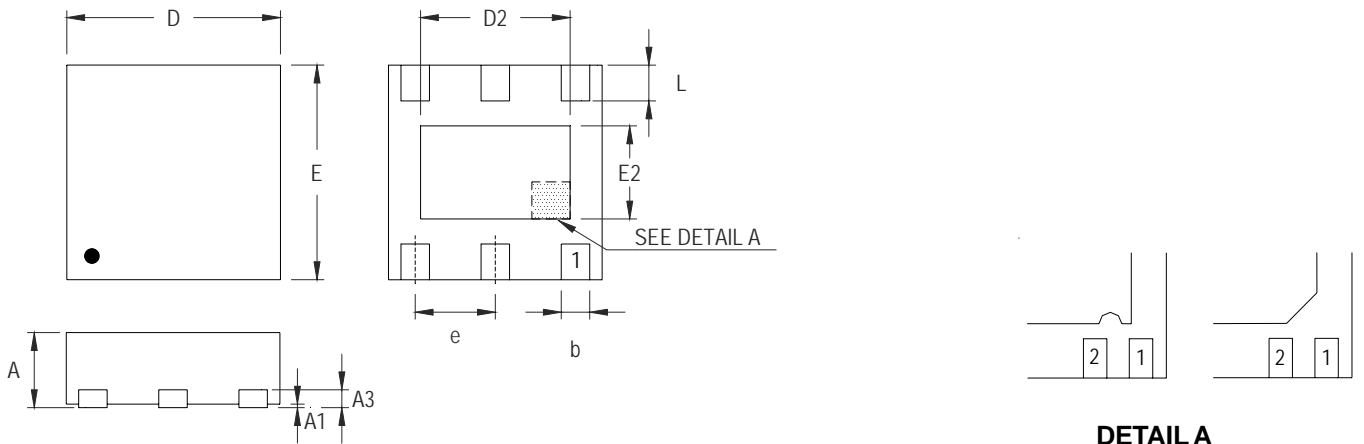
Figure 4. Scope Photo of the V-com Peak Current

Outline Dimension



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.889	1.295	0.035	0.051
A1	0.000	0.152	0.000	0.006
B	1.397	1.803	0.055	0.071
b	0.356	0.559	0.014	0.022
C	2.591	2.997	0.102	0.118
D	2.692	3.099	0.106	0.122
e	0.838	1.041	0.033	0.041
H	0.080	0.254	0.003	0.010
L	0.300	0.610	0.012	0.024

SOT-23-5 Surface Mount Package



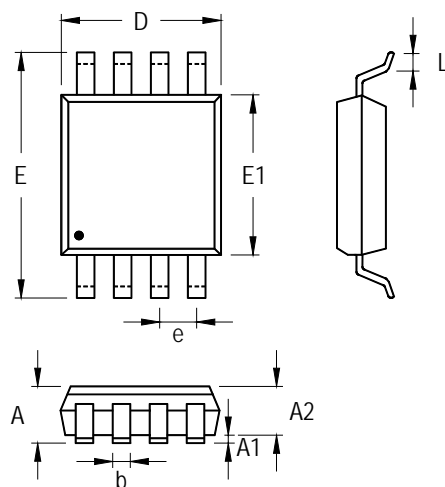
DETAIL A

Pin #1 ID and Tie Bar Mark Options

Note : The configuration of the Pin #1 identifier is optional, but must be located within the zone indicated.

Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.700	0.800	0.028	0.031
A1	0.000	0.050	0.000	0.002
A3	0.175	0.250	0.007	0.010
b	0.200	0.350	0.008	0.014
D	1.950	2.050	0.077	0.081
D2	1.000	1.450	0.039	0.057
E	1.950	2.050	0.077	0.081
E2	0.500	0.850	0.020	0.033
e	0.650		0.026	
L	0.300	0.400	0.012	0.016

W-Type 6L DFN 2x2 Package



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.810	1.100	0.032	0.043
A1	0.000	0.150	0.000	0.006
A2	0.750	0.950	0.030	0.037
b	0.220	0.380	0.009	0.015
D	2.900	3.100	0.114	0.122
e	0.650		0.026	
E	4.800	5.000	0.189	0.197
E1	2.900	3.100	0.114	0.122
L	0.400	0.800	0.016	0.031

8-Lead MSOP Plastic Package

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